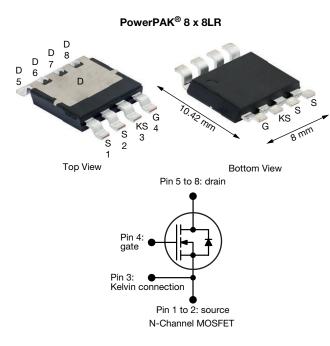
Vishay Siliconix

VISHAY. www.vishay.com

E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.074			
Q _g max. (nC)	63				
Q _{gs} (nC)	19				
Q _{gd} (nC)	10				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8LR
Lead (Pb)-free and halogen-free	SiHR080N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-source voltage		V _{DS}	600	v			
Gate-source voltage			V _{GS}	± 30	v		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	Ι _D	51			
	VGS at TO V	$T_{\rm C} = 100 ^{\circ}{\rm C}$		32	А		
Pulsed drain current ^a			I _{DM}	96			
Linear derating factor			4.0	W/°C			
Single pulse avalanche energy ^b		E _{AS} 173		mJ			
Maximum power dissipation		PD	P _D 500				
Operating junction and storage temperature ra	ange		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope		T _J = 125 °C	100		V/ns		
Reverse diode dv/dt ^d			dv/dt	10	v/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 120 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 28.2 mH, $R_q = 25 \Omega$, $I_{AS} = 3.5 \text{ A}$

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

S24-0968-Rev. B, 23-Sep-2024

1



COMPLIANT

HALOGEN

FREE



Vishay Siliconix

THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 42			00.004			
Maximum junction-to-case (drain)	R _{thJC}	- 0.25				°C/W		
	•	•			•			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.64	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
		$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA
Gate-source leakage	I _{GSS}	, v	V _{GS} = ± 30 V			-	± 1	μA
		V _{DS} =	= 600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	′, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١	_D = 17 A	-	0.074	0.084	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D =	= 17 A	-	4.6	-	S
Dynamic					•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2557	-	pF	
Output capacitance	C _{oss}			-	105	-		
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	79	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	499	-		
Total gate charge	Qg				-	42	63	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 17 A, V _{DS} = 480 V		-	19	-	nC
Gate-drain charge	Q _{gd}				-	10	-	
Turn-on delay time	t _{d(on)}		•		-	31	62	
Rise time	t _r	V _{DD} =	V_{DD} = 480 V, I _D = 17 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	96	144	ns
Turn-off delay time	t _{d(off)}				-	37	74	
Fall time	t _f			-	31	62		
Gate input resistance	R _g	f = 1 MHz		0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	IS	MOSFET sym showing the	MOSFET symbol showing the		-	-	51	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	96	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 17 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 17 \text{ A},$ di/dt = 80 A/µs, V _R = 25 V		-	441	882	ns	
Reverse recovery charge	Q _{rr}			-	5.2	10.4	μC	
Reverse recovery current	I _{RRM}			-	21	_	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

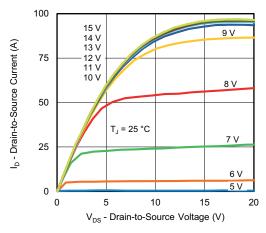


Fig. 1 - Typical Output Characteristics

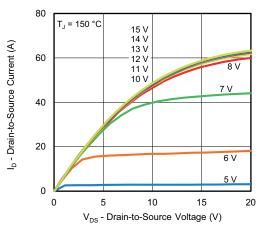


Fig. 2 - Typical Output Characteristics

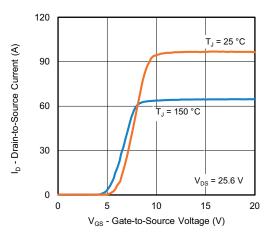


Fig. 3 - Typical Transfer Characteristics

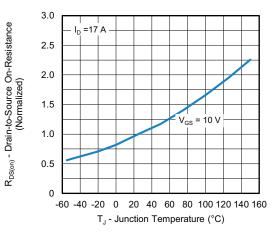


Fig. 4 - Normalized On-Resistance vs. Temperature

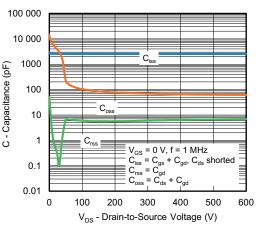


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

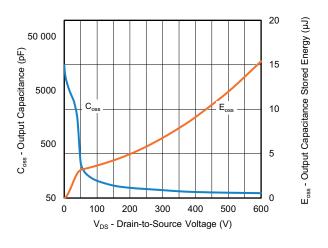


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92494

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay Siliconix

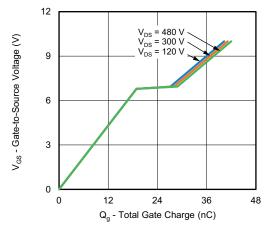


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

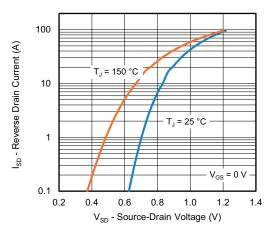


Fig. 8 - Typical Source-Drain Diode Forward Voltage

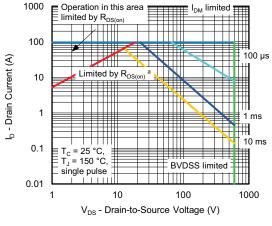
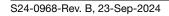


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



4

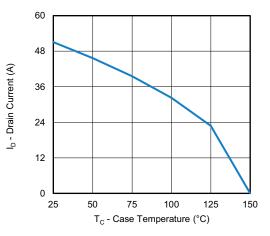


Fig. 10 - Maximum Drain Current vs. Case Temperature

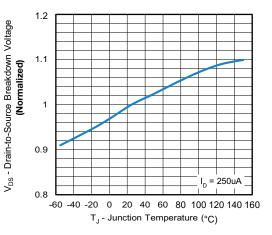


Fig. 11 - Temperature vs. Drain-to-Source Voltage



Vishay Siliconix

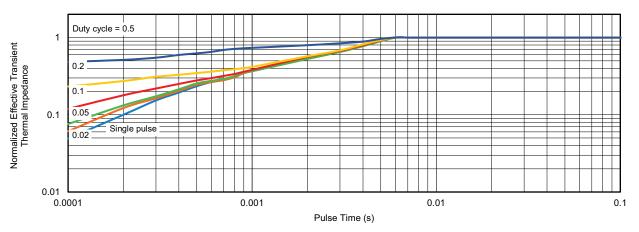


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

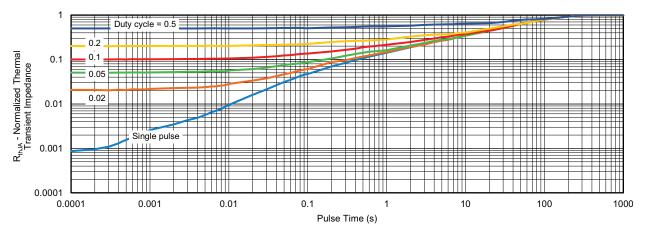


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

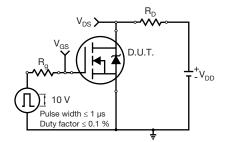


Fig. 14 - Switching Time Test Circuit

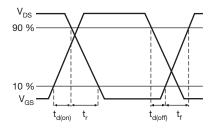


Fig. 15 - Switching Time Waveforms

5



Vishay Siliconix

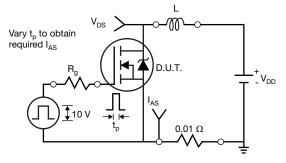


Fig. 16 - Unclamped Inductive Test Circuit

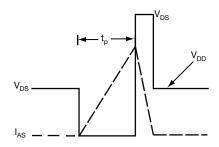


Fig. 17 - Unclamped Inductive Waveforms

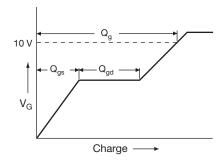


Fig. 18 - Basic Gate Charge Waveform

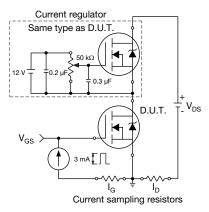


Fig. 19 - Gate Charge Test Circuit

6



Vishay Siliconix

Peak Diode Recovery dv/dt Test Circuit

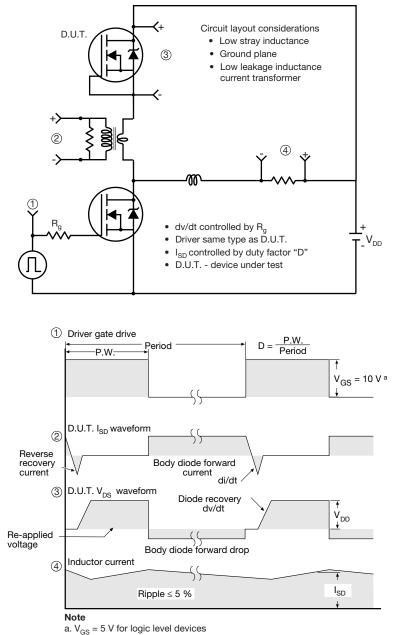


Fig. 20 - For N-Channel

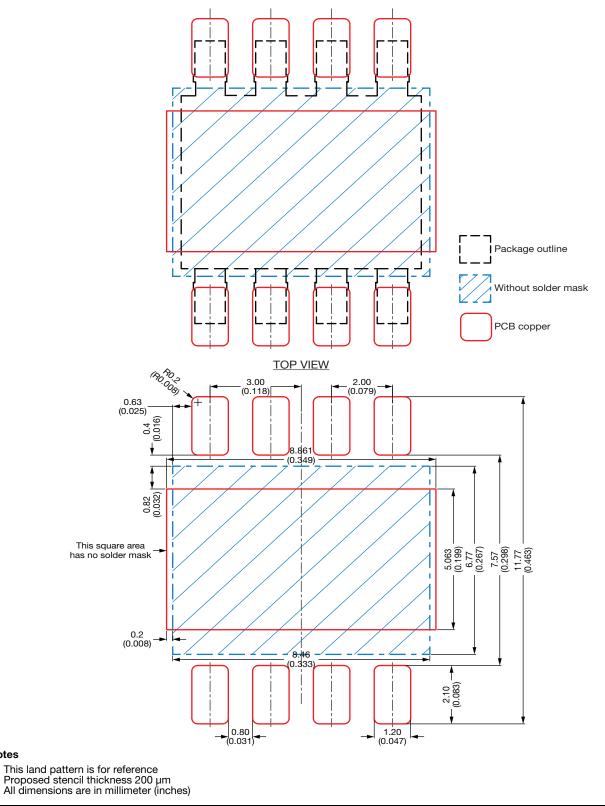
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92494.

PAD Pattern



Vishay Siliconix

Recommended Land Pattern PowerPAK® 8 x 8LR



ECN: S23-1106-Rev. A, 11-Dec-2023 DWG: 3022

Revision: 11-Dec-2023

Notes

1

Document Number: 92534

For technical questions, contact: HVM@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2024 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jul-2024